# onsemi

### Quad 2-Input AND Gate 74VHC08

#### **General Description**

The VHC08 is an advanced high speed CMOS 2 Input AND Gate fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 4 stages including buffer output, which provide high noise immunity and stable output. An input protection circuit insures that 0 V to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

#### Features

- High Speed:  $t_{PD} = 4.3 \text{ ns} (Typ.) \text{ at } T_A = 25^{\circ}\text{C}$
- High Noise Immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (Min.)
- Power Down Protection is Provided on All Inputs
- Low Power Dissipation:  $I_{CC} = 2 \mu A (Max.) @ T_A = 25^{\circ}C$
- Low Noise:  $V_{OLP} = 0.8 V$  (Max.)
- Pin and Function Compatible with 74HC08
- Pb-Free, Halogen Free/BFR Free and RoHS Compliant

#### Logic Symbol

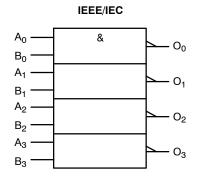
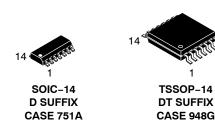
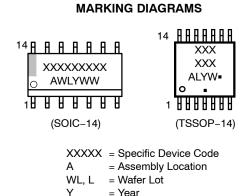


Figure 1. Logic Symbol

TRUTH TABLE

А	В	0
L	L	L
L	Н	L
Н	L	L
Н	Н	н

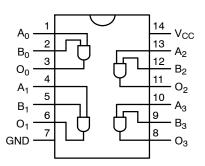




G or • = Pb-Free Package (Note: Microdot may be in either location)

WW, W = Work Week

#### **CONNECTION DIAGRAM**



#### **PIN DESCRIPTION**

Pin Names	Description
A <sub>n</sub> , B <sub>n</sub>	Inputs
O <sub>n</sub>	Outputs

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 4 of this data sheet.

#### MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage	–0.5 to +6.5	V
V <sub>IN</sub>	DC Input Voltage	–0.5 to +6.5	V
V <sub>OUT</sub>	DC Output Voltage	–0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IN</sub>	DC Input Current, per Pin	±20	mA
I <sub>OUT</sub>	DC Output Current, per Pin	±25	mA
I <sub>CC</sub>	DC Supply Current, V <sub>CC</sub> and GND Pins	±50	mA
I <sub>IK</sub>	Input Clamp Current	-20	mA
I <sub>OK</sub>	Output Clamp Current	±20	mA
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 seconds	260	°C
ТJ	Junction Temperature Under Bias	+150	°C
$\theta_{JA}$	Thermal Resistance (Note 1) SOIC-14 TSSOP-14	116 150	°C/W
P <sub>D</sub>	Power Dissipation in Still Air at 25°C SOIC-14 TSSOP-14	1077 833	mW
V <sub>ESD</sub>	ESD Withstand Voltage (Note 2) Human Body Model Charged Device Model	> 2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.

2. HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	DC Supply Voltage	2.0	5.5	V
V <sub>IN</sub>	DC Input Voltage (Note 3)	0	5.5	V
V <sub>OUT</sub>	DC Output Voltage (Note 3)	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature	-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Rate $V_{CC} = 3.0 \text{ V}$ to 3.6 V $V_{CC} = 4.5 \text{ V}$ to 5.5 V	0 0	100 20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must be held HIGH or LOW. They may not float.



#### DC ELECTRICAL CHARACTERISTICS

						T <sub>A</sub> = 25°C		T <sub>A</sub> = -40°0	C to +85°C					
Symbol	Parameter	V <sub>CC</sub> (V)	Con	ditions	Min	Тур	Max	Min	Max	Unit				
V <sub>IH</sub>	HIGH Level Input	2.0			1.50	-	-	1.50	-	V				
	Voltage	3.0–5.5			0.7 x V <sub>CC</sub>	-	-	$0.7 \times V_{CC}$	-	1				
V <sub>IL</sub>	LOW Level Input	2.0			-	-	0.50	-	0.50	V				
	Voltage	3.0–5.5			-	-	0.3 x V <sub>CC</sub>	-	0.3 x V <sub>CC</sub>	1				
V <sub>OH</sub>	HIGH Level Output	2.0	$V_{IN} = V_{IH}$	I <sub>OH</sub> = -50 μA	1.9	2.0	-	1.9	-	V				
	Voltage	3.0	or V <sub>IL</sub>		2.9	3.0	-	2.9	-	]				
		4.5	5		4.4	4.5	-	4.4	-	]				
		3.0		I <sub>OH</sub> =4 mA	2.58	-	-	2.48	-	]				
		4.5		I <sub>OH</sub> =8 mA	3.94	-	-	3.80	-	1				
V <sub>OL</sub>	LOW Level Output Voltage	2.0	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	l <sub>OL</sub> = 50 μA	-	0.0	0.1	-	0.1	V			
	vollage	3.0			orv <sub>IL</sub>				-	0.0	0.1	-	0.1	]
		4.5					-	0.0	0.1	-	0.1	1		
		3.0		I <sub>OL</sub> = 4 mA	-	-	0.36	-	0.44	]				
		4.5		I <sub>OL</sub> = 8 mA	-	-	0.36	-	0.44	1				
I <sub>IN</sub>	Input Leakage Current	0–5.5	V <sub>IN</sub> = 5.5 V c	or GND	-	-	±0.1	-	±1.0	μΑ				
Icc	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or	GND	-	-	2.0	-	20.0	μΑ				

#### NOISE CHARACTERISTICS

				T <sub>A</sub> = 25°C		
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Тур	Limits	Unit
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub> (Note 4)	5.0	C <sub>L</sub> = 50 pF	0.3	0.8	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic $V_{OL}$ (Note 4)	5.0	C <sub>L</sub> = 50 pF	-0.3	-0.8	V
V <sub>IHD</sub>	Minimum HIGH Level Dynamic Input Voltage (Note 4)	5.0	C <sub>L</sub> = 50 pF	-	3.5	V
V <sub>ILD</sub>	Maximum LOW Level Dynamic Input Voltage (Note 4)	5.0	C <sub>L</sub> = 50 pF	-	1.5	V

4. Parameter guaranteed by design.

#### AC ELECTRICAL CHARACTERISTICS

				T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C to +85°C		
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	3.3 ±0.3	C <sub>L</sub> = 15 pF	-	6.2	8.8	1.0	10.5	ns
			C <sub>L</sub> = 50 pF	-	8.7	12.3	1.0	14.0	1
		5.0 ±0.5	C <sub>L</sub> = 15 pF	-	4.3	5.9	1.0	7.0	ns
			C <sub>L</sub> = 50 pF	-	5.8	7.9	1.0	9.0	1
C <sub>IN</sub>	Input Capacitance		V <sub>CC</sub> = Open	-	4	10	-	10	pF
C <sub>PD</sub>	Power Dissipation Capacitance		(Note 5)	-	18	-	_	-	pF

5.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC}$  (opr.) =  $C_{PD} \times V_{CC} \times f_{IN} + I_{CC} / 4$  (per gate).



### 74VHC08

#### **ORDERING INFORMATION**

Device Order Number	Top Marking	Package Type	Shipping <sup>†</sup>
74VHC08M	VHC08G	SOIC-14 (Pb-Free, Halide Free)	55 / Tube
74VHC08MX	VHC08G	SOIC-14 (Pb-Free, Halide Free)	2,500 / Tape & Reel
74VHC08MTCX	VHC 08	TSSOP-14 (Pb-Free, Halide Free)	2,500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



### onsemi



\*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **STYLES ON PAGE 2**

 
 DOCUMENT NUMBER:
 98ASB42565B
 Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.

 DESCRIPTION:
 SOIC-14 NB
 PAGE 1 OF 2

 onsemi and ONSEMi. are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi axis me any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

#### SOIC-14 CASE 751A-03 ISSUE L

#### DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

DOCUMENT NUMBER:	98ASB42565B	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOIC-14 NB		PAGE 2 OF 2	

onsemi and ONSEMI: are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

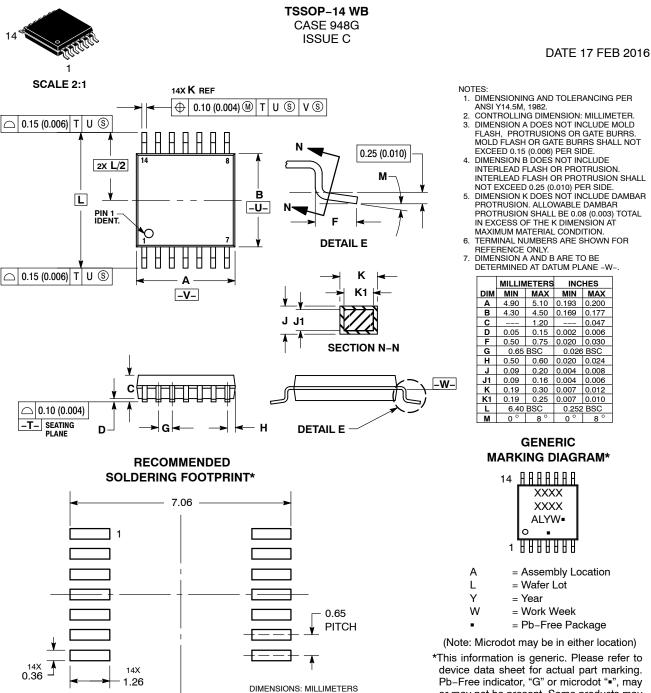
## onsemi

SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 Α 8.50 0.65 7.62 14 8 14 8 В ₽ ╞ 4.00 6.00 5.60 3.80 Ħ = ╞ = Ħ 1.70 7 **PIN #1** 7 1.27 1 0.51 IDENT. 1.270.35 (0.33) - $\oplus$  0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 0.19 0.10 С 1.50 0.25 1.25 0.10 SIDE VIEW FRONT VIEW NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS R0.10 GAGE D. LAND PATTERN STANDARD: PLANE SOIC127P600X145-14M E. CONFORMS TO ASME Y14.5M, 2009 R0.10 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)**DETAIL A** SCALE 16:1

DOCUMENT NUMBER:	98AON13739G	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOIC14		PAGE 1 OF 1	

onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

### semi



\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT
- INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98ASH70246A Electronic versions are uncontrolled except when accessed directly from the Document Reposito Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	TSSOP-14 WB		PAGE 1 OF 1		
onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves					

the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>